

N-CHANNEL 600V - 0.098Ω - 40A ISOTOP PowerMesh™II MOSFET

| TYPE | V _{DSS} | R _{DS(on)} | I _D |
|-----------|------------------|---------------------|----------------|
| STE40NC60 | 600V | < 0.13Ω | 40 A |

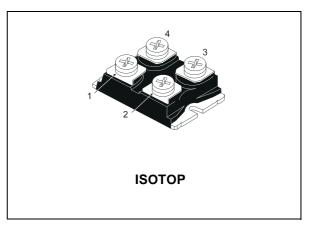
- TYPICAL $R_{DS}(on) = 0.098 \Omega$
- EXTREMELY HIGH dv/dt CAPABILITY
 400% AV(ALANCUE TESTED
- 100% AVALANCHE TESTED
- NEW HIGH VOLTAGE BENCHMARK
- GATE CHARGE MINIMIZED

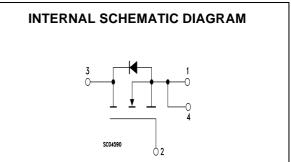
DESCRIPTION

The PowerMESHTMII is the evolution of the first generation of MESH OVERLAYTM. The layout refinements introduced greatly improve the Ron*area figure of merit while keeping the device at the leading edge for what concerns swithing speed, gate charge and ruggedness.

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SWITH MODE POWER SUPPLIES (SMPS)
- DC-AC CONVERTERS FOR WELDING EQUIPMENT AND UNINTERRUPTIBLE POWER SUPPLIES AND MOTOR DRIVER





ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|-----------------------------|--|--|------|
| V _{DS} | Drain-source Voltage ($V_{GS} = 0$) | 600 | V |
| V _{DGR} | Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$) | 600 | V |
| V _{GS} | Gate- source Voltage | ±30 | V |
| Ι _D | Drain Current (continuos) at T _C = 25°C | 40 | Α |
| I _D | Drain Current (continuos) at T _C = 100°C | 23 | Α |
| I _{DM} (•) | Drain Current (pulsed) | 160 | Α |
| P _{TOT} | Total Dissipation at $T_C = 25^{\circ}C$ | 460 | W |
| | Derating Factor | 3.68 | W/°C |
| dv/dt (1) | Peak Diode Recovery voltage slope | 3 | V/ns |
| VISO | Insulation Winthstand Voltage (AC-RMS) | 2500 | V |
| T _{stg} | Storage Temperature | -65 to 150 | °C |
| Tj | Max. Operating Junction Temperature | 150 | °C |
|)Pulse width li Iay 2002 | mited by safe operating area | (1) I _{SD} ≤ 40A, di/dt≤100 A/μs, V _{DD} ≤ 24V, Tj≤T _{jMAX} | 1/8 |

THERMAL DATA

| Rthj-case | Thermal Resistance Junction-case | Max | 0.272 | °C/W |
|-----------|--|------------|-------|------|
| Rthc-h | Thermal Resistance Case-heatsink with C Grease Applied | Conductive | 0.05 | °C/W |

AVALANCHE CHARACTERISTICS

| Symbol | Parameter | Max Value | Unit |
|-----------------|---|-----------|------|
| I _{AR} | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T_j max) | 40 | A |
| E _{AS} | Single Pulse Avalanche Energy (starting $T_j = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$) | 1150 | mJ |

ELECTRICAL CHARACTERISTICS (TCASE = 25 °C UNLESS OTHERWISE SPECIFIED) OFF

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|----------------------|--|---|------|------|-----------|----------|
| V _{(BR)DSS} | Drain-source Breakdown Voltage | I _D = 250 μA, V _{GS} = 0 | 600 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V_{DS} = Max Rating V_{DS} = Max Rating, T _C = 125 °C | | | 10 100 | μΑ μΑ |
| I _{GSS} | Gate-body Leakage Current (V _{DS} = 0) | $V_{GS} = \pm 30V$ | | | ±100 | nA |

ON (1)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------|--------------------------------------|---|------|-------|-------|------|
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2 | 3 | 4 | V |
| R _{DS(on)} | Static Drain-source On Resistance | V _{GS} = 10V, I _D = 20A | | 0.098 | 0.130 | Ω |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------------------|--|------|------|------|------|
| g _{fs} (1) | Forward Transconductance | $V_{DS} > I_{D(on)} \times R_{DS(on)max,}$ $I_{D} = 15 \text{ A}$ | | 42 | | S |
| Ciss | Input Capacitance | $V_{DS} = 25V, f = 1 \text{ MHz}, V_{GS} = 0$ | | 11.1 | | nF |
| Coss | Output Capacitance | | | 1190 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 100 | | pF |

Note: 1. Pulsed: Pulse duration = $300 \ \mu$ s, duty cycle 1.5 %.

ELECTRICAL CHARACTERISTICS (CONTINUED)

SWITCHING ON

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--------------------|--------------------|--|------|-------|------|------|
| t _{d(on)} | Turn-on Delay Time | $V_{DD} = 300 \text{ V}, I_D = 20 \text{ A}$ | | 49 | | ns |
| tr | Rise Time | $R_G = 4.7\Omega V_{GS} = 10V$ (see test circuit, Figure 3) | | 42 | | ns |
| Qg | Total Gate Charge | $V_{DD} = 480V, I_D = 40A,$ | | 307.5 | 430 | nC |
| Q _{gs} | Gate-Source Charge | V _{GS} = 10V | | 48 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 146.5 | | nC |

SWITCHING OFF

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|----------------------|-----------------------|---|------|------|------|------|
| t _{r(Voff)} | Off-voltage Rise Time | $V_{DD} = 480V, I_D = 40A,$ | | 41 | | ns |
| t _f | Fall Time | $R_G = 4.7\Omega, V_{GS} = 10V$ (see test circuit, Figure 5) | | 26 | | ns |
| t _c | Cross-over Time | | | 74 | | ns |

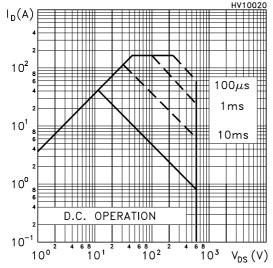
SOURCE DRAIN DIODE

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|----------------------|-------------------------------|---|------|------|------|------|
| I _{SD} | Source-drain Current | | | | 40 | А |
| I _{SDM} (2) | Source-drain Current (pulsed) | | | | 160 | А |
| V _{SD} (1) | Forward On Voltage | $I_{SD} = 40A, V_{GS} = 0$ | | | 1.6 | V |
| t _{rr} | Reverse Recovery Time | I _{SD} = 40 A, di/dt = 100 A/µs, | | 685 | | ns |
| Qrr | Reverse Recovery Charge | V _{DD} = 40 V, T _j = 150 °C (see test circuit, Figure 5) | | 15 | | μC |
| I _{RRM} | Reverse Recovery Current | | | 44 | | А |

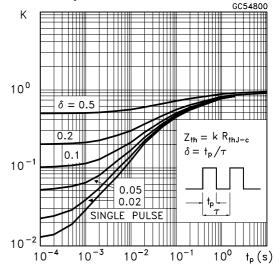
 Note:
 1. Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.

 2. Pulse width limited by safe operating area.

Safe Operating Area

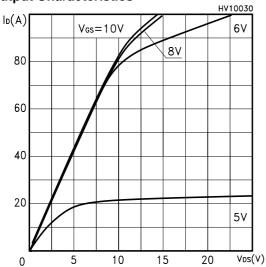


Thermal Impedence

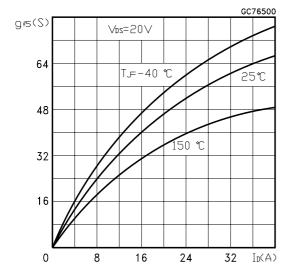


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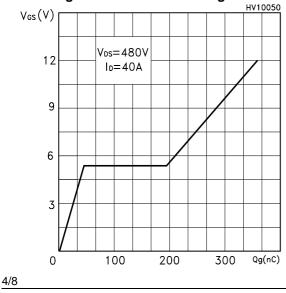
Output Characteristics



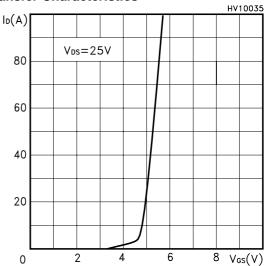
Transconductance



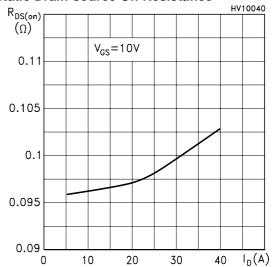
Gate Charge vs Gate-source Voltage

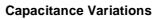


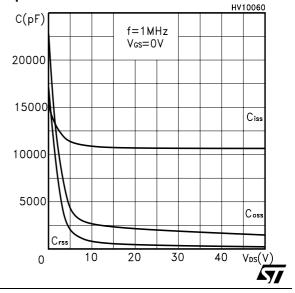
Transfer Characteristics

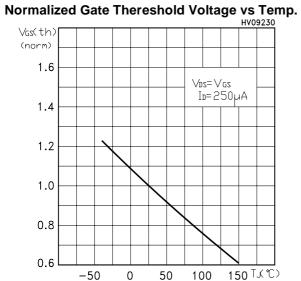


Static Drain-source On Resistance

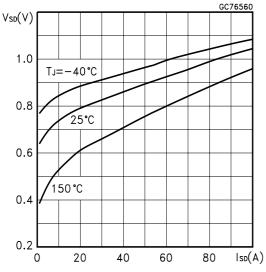






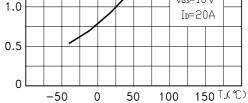


Source-drain Diode Forward Characteristics



Ros(on) (norm) 2.5 2.0 1.5 VGs=10∨ 1.0

Normalized On Resistance vs Temperature



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Fig. 1: Unclamped Inductive Load Test Circuit

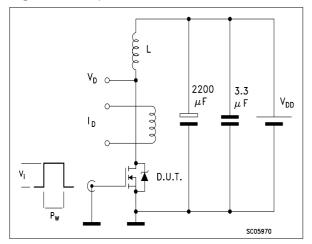


Fig. 3: Switching Times Test Circuit For Resistive Load

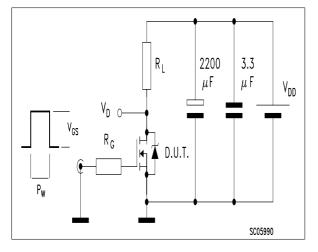
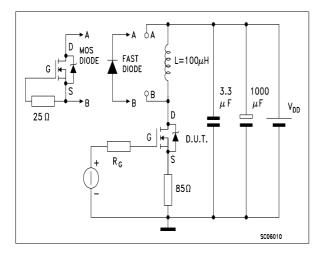


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times



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Fig. 2: Unclamped Inductive Waveform

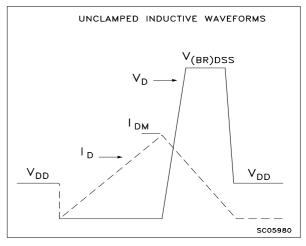
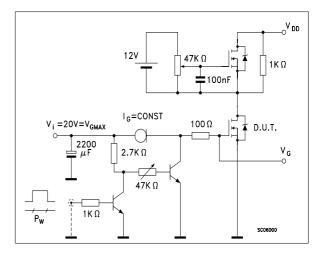


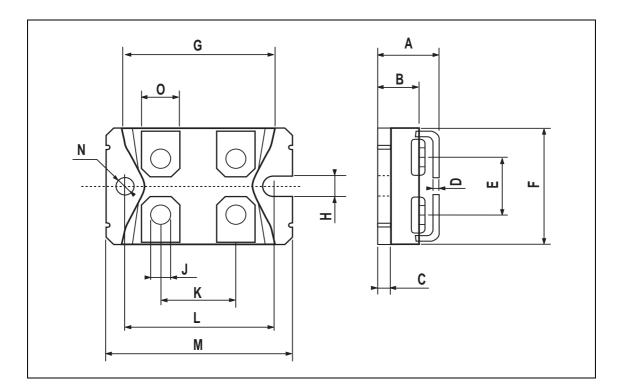
Fig. 4: Gate Charge test Circuit





| DIM. | | mm | | inch | | | |
|-------|-------|------|------|-------|------|-------|--|
| Diwi. | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | |
| А | 11.8 | | 12.2 | 0.466 | | 0.480 | |
| В | 8.9 | | 9.1 | 0.350 | | 0.358 | |
| С | 1.95 | | 2.05 | 0.076 | | 0.080 | |
| D | 0.75 | | 0.85 | 0.029 | | 0.033 | |
| E | 12.6 | | 12.8 | 0.496 | | 0.503 | |
| F | 25.15 | | 25.5 | 0.990 | | 1.003 | |
| G | 31.5 | | 31.7 | 1.240 | | 1.248 | |
| Н | 4 | | | 0.157 | | | |
| J | 4.1 | | 4.3 | 0.161 | | 0.169 | |
| К | 14.9 | | 15.1 | 0.586 | | 0.594 | |
| L | 30.1 | | 30.3 | 1.185 | | 1.193 | |
| М | 37.8 | | 38.2 | 1.488 | | 1.503 | |
| Ν | 4 | | | 0.157 | | | |
| 0 | 7.8 | | 8.2 | 0.307 | | 0.322 | |

ISOTOP MECHANICAL DATA



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